

3.3V Fast CMOS Buffer/Clock Driver

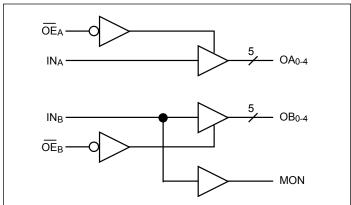
Features

- → 3.3V version of PI49FCT805/806
- → Extremely low output skew: 0.5ns
- → Monitor output pin
- → Clock busing with 3-state control
- → TTL input and CMOS output compatible
- → Industrial operation at -40°C to 85°C
- → Extremely low static power (1mW, typ.)
- → Hysteresis on all inputs
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
 - https://www.diodes.com/quality/product-definitions/
- → Packaging (Pb-free & Green available):
 - 20-pin 150-mil wide QSOP (Q)
 - 20-pin 209-mil wide SSOP (H)

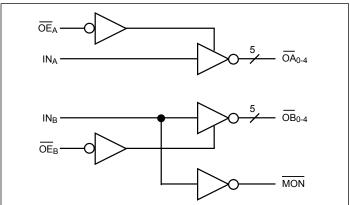
Description

Diodes' PI49FCT3805 is a 3.3V non-inverting clock driver and the PI49FCT3806 is a 3.3V inverting clock driver designed with two independent groups of buffers. These buffers have 3-state Output Enable inputs (active LOW) with a 1-in, 5-out configuration per group. Each clock driver consist of two banks of drivers, driving five outputs each from a standard TTL compatible CMOS input.

PI49FCT3805 Block Diagram



PI49FCT3806 Block Diagram

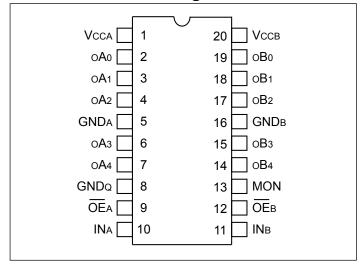


Notes:

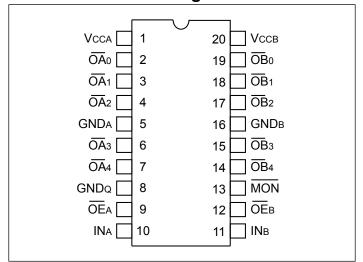
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



PI49FCT3805 Pin Configuration



PI49FCT3806 Pin Configuration



Pin Description

Pin Name	Description		
$\overline{\mathrm{OE}}_{\mathrm{A}}, \overline{\mathrm{OE}}_{\mathrm{B}}$	3-State Output Enable Inputs (Active LOW)		
IN _A , IN _B	Clock Inputs		
OA_N, OB_N	Clock Outputs		
MON	Monitor Output		
GND	Ground		
V _{CC}	Power		

PI49FCT3805 Truth Table⁽¹⁾

Inpu	uts	Outputs		
\overline{OE}_A , \overline{OE}_B	IN _A , IN _B	_O A _N , _O B _N	MON	
L	L	L	L	
L	Н	Н	Н	
Н	L	Z	L	
Н	Н	Z	Н	

Note:

1. H = High Voltage Level, L = Low Voltage Level Z = High Impedance

PI49FCT3806 Truth Table⁽¹⁾

Inp	outs	Output	s
\overline{OE}_A , \overline{OE}_B	IN _A , IN _B	\overline{OA}_N , \overline{OB}_N	MON
L	L	Н	Н
L	Н	L	L
Н	L	Z	Н
Н	Н	Z	L

Note:

1. H = High Voltage Level, L = Low Voltage Level, Z = High Impedance





Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied -40°C to +85°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)–0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & I/O Only) .–0.5V to +7.0V
DC Input Voltage0.5V to +7.0V
DC Output Current
Power Dissipation

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics ($T_A = -40$ °C to +85°C, $V_{CC} = 3.3V \pm 0.3V$)

Symbol	Parameter	Test Condition ⁽¹⁾	Test Condition ⁽¹⁾			Max.	Units
V _{OH}	Output High Voltage $V_{CC} = 3.0V$, $V_{IN} = V_{IL}$ or V_{IH}	$V_{CC} = Min.,$ $V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -0.1 \text{mA}$ $I_{OH} = -8 \text{mA}$	V _{CC} -0.2 2.4 (3)	3.0		
V _{OL}	Output Low Voltage $V_{CC} = 3.0V$, $V_{IN} = V_{IL}$ or V_{IH}	$V_{CC} = Min.,$ $V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 0.1 \text{mA}$ $I_{OL} = 16 \text{mA}$ $I_{OL} = 24 \text{mA}$		0.2 0.3	0.2 0.4 0.5	V
V_{IH}	Input High Voltage	Guaranteed Logic HIGH level	Input Pins	2.0		5.5	
V _{IL}	Input Low Voltage	Guaranteed Logic LOW level	Input Pins	-0.5		0.8	
I_{IH}	Input High Current	V _{CC} = Max	V _{IN} = V _{CC} (Input Pins)	-1		1	
I_{IL}	Input Low Current	V _{CC} = Max	V _{IN} = GND (Input & I/O Pins)	-1		1	μΑ
I _{OZH}	High Impedance Output Current	V _{CC} = Max., All outputs Disabled				1	μπ
I _{OZL}	High Impedance Output Current	V _{CC} = Max., All outputs Disabled	$V_{OUT} = V_{CC}$ $V_{OUT} = GND$	-1		1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18m	A		-0.7	-1.2	V
I _{ODH}	Output HIGH Current	V_{OUT} = 3.3V, V_{IN} = V_{IL} or V_{IH} , V_{OUT} = 1.5V ⁽⁴⁾		-35	-86	-110	
I _{ODL}	Output LOW Current	V_{OUT} = 3.3V, V_{IN} = V_{IL} or V_{IH} , V_{OUT} = 1.5V ⁽⁴⁾		50	168	200	mA
I _{OS}	Short Circuit ⁽⁵⁾ Current	$V_{CC} = Max., V_{OUT} = GI$	ND ⁽⁵⁾	-60	-135	-240	
V_{H}	Input Hysteresis				150		mV

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type. 2. Typical values are at $V_{CC} = 3.3V$, $\pm 25^{\circ}C$ ambient and maximum loading.
- 3. $V_{OH} = V_{CC} 0.6V$ at rated current.
- 4. This parameter is determined by device characterization but is not production tested.





Power Supply Characteristics ($T_A = -40$ °C to +85°C, $V_{CC} = 3.3 V \pm 0.3 V$)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I_{CC}	Quiescent Power Supply Current	V _{CC} = Max.	$V_{IN} = GND \text{ or } V_{CC}$	_		30	4
ΔI_{CC}	Supply Current per Inputs @ TTL HIGH	V _{CC} = Max.	$V_{IN} = V_{CC} - 0.6V^{(3)}$	_	11	300	μΑ
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	$V_{CC} = Max.,$ Outputs Open $\overline{OE}_A \text{ or } \overline{OE}_B = GND$ $V_{IN} = V_{CC}$ Per Output Toggling $V_{IN} = V_{CC}$ $V_{IN} = V_{CC}$		_	0.1	0.16	mA/ MHz
		V _{CC} = Max., Outputs Open FO = 10 MHz	$V_{IN} = V_{CC}$ $V_{IN} = GND$	_	3.3	9.0 ⁽⁵⁾	
T-	Total Power Supply	\overline{OE}_{A} or \overline{OE}_{B} = GND Mon. Outputs Toggling	$V_{IN} = V_{CC} - 0.6V$ $V_{IN} = GND$	l	3.3	10.0 ⁽⁵⁾	mA
I _C	Current ⁽⁶⁾	$V_{CC} = Max.,$ Outputs Open $f_{O} = 2.5 \text{ MHz}$	$V_{IN} = V_{CC}$ $V_{IN} = GND$		1.8	6.0 ⁽⁵⁾	IIIA
		50% Duty Cycle $\overline{OE}_{A} \text{ or } \overline{OE}_{B} = GND$ Eleven Outputs Toggling	$V_{\rm IN} = V_{\rm CC} - 0.6V$ $V_{\rm IN} = {\rm GND}$	_	1.8	7.0 ⁽⁵⁾	

Note:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at $V_{CC} = 3.3V$, $+25^{\circ}C$ ambient.
- 3. Per TTL driven input (V_{IN} = V_{CC} 0.6V); all other inputs at V_{CC} or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the Ic formula. These limits are guaranteed but not tested.
- 6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$

 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_O N_O)$

I_{CC} = Quiescent Current

 ΔI_{CC} = Power Supply Current for a TTL High Input (V $_{IN}$ = V $_{CC}$ – 0.6V)

D_H = Duty Cycle for TTL Inputs High

 N_T = Number of TTL Inputs at D_H

 I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

f_O = Output Frequency

 N_O = Number of Outputs at f_O

All currents are in milliamps and all frequencies are in megahertz.





Capacitance ($T_A = 25^{\circ}C$, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Тур	Max.	Units
C _{IN}	Input Capacitance	$V_{IN} = 0V$	3.0	6.0	T
C _{OUT}	Output Capacitance	$V_{OUT} = 0V$	6.0	8.0	pF

Note:

Switching Characteristics ($T_A = -40$ °C to +85°C, $V_{CC} = 3.3V \pm 0.3V$)

				305 306)5A)5B)6B)5C	
		Test		om.)6A om.)бБ om.	-)6C om.	Units
Parameter	Description	Conditions ⁽¹⁾	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{PLH}	Propagation Delay IN _A to OA_N , IN _B to OB_N		1.5	6.5	1.5	5.8	1.5	5.0	1.5	4.5	
t _{PZH}	$\frac{Output\ Enable\ Time}{OE_A\ to\ OA_N,\ \overline{OE}_B\ to\ OB_N}$		1.5	8.0	1.5	8.0	1.5	6.5	1.5	6.2	
t _{PHL}			1.5	7.0	1.5	7.0	1.5	6.0	1.5	5.0	
t _{SK(o)} ⁽³⁾	Skew between two outputs of same package (same transition)	$C_{L} = 50 pF$ $R_{L} = 500 \Omega$		0.7		0.7		0.5		0.5	ns
t _{SK(P)} (3)	Skew between opposite transitions ($_{tPHL}$ - t_{PLH}) of the same output			1.0		0.7		0.5		0.5	
$t_{SK(t)}^{(3)}$	Skew between two outputs of different package at same temperature (Same transition)			1.5		1.2		1.0		0.8	

Note:

- 1. See test circuit and waveforms
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. Skew measured at worst cast temperature (max. temp).

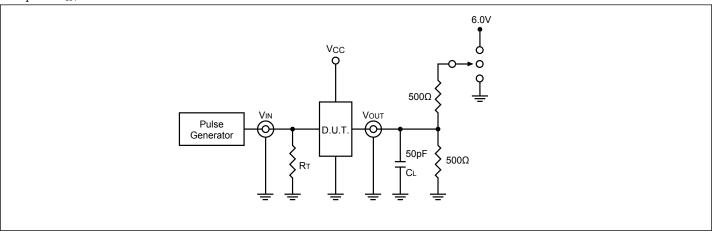
^{1.} This parameter is determined by device characterization but is not production tested.





Tests Circuits for All Outputs

Except for F_{IN} >100 MHz



Switch Position

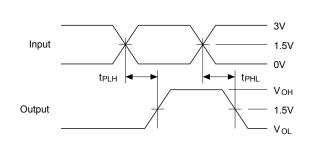
Test	Switch
Disable LOW	6V
Enable LOW	O V
Disable HIGH	GND
Enable HIGH	GND
All Other Inputs	Open

Definitions:

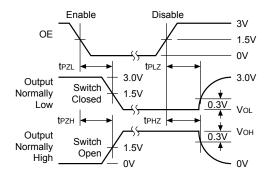
$$\begin{split} &C_L = Load \ capacitance: includes jig \ and \ probe \ capacitance. \\ &R_T = Termination \ resistance: should be equal to \ ZOUT \ of the \ Pulse \ Generator. \end{split}$$



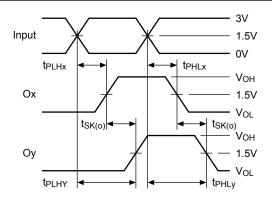
Switching Waveforms



Propagation Delay

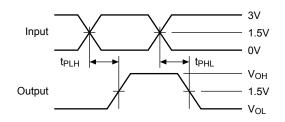


Enable and Disable Times



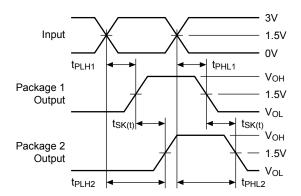
 $t_{SK(0)} = |t_{PLHy} - t_{PLHx}| \text{ or } |t_{PHLy} - t_{PHLx}|$





 $t_{SK(D)} = |t_{PHL} - t_{PLH}|$

Pulse Skew - t_{SK(P)}



 $t_{SK(t)}$ = | $t_{PLH2} - t_{PLH1}$ | or | $t_{PHL2} - t_{PHL1}$ |

Package Skew - t_{SK(t)}





Part Marking

PI49FCT3805 Q Package



B on the Part# = Speed Code

B: Fab 2 Port Code W: Die Rev

YY: Year WW: Workweek

1st X: Assembly Code

2nd X: Fab Code

PI49FCT 3805QEC **BWYYWWXX**

C on the Part# = Speed Code B: Fab 2 Port Code

W: Die Rev YY: Year

WW: Workweek

1st X: Assembly Code

2nd X: Fab Code



B: Fab 2 Port Code

W: Die Rev YY: Year

WW: Workweek

1st X: Assembly Code 2nd X: Fab Code

H Package



C on the Part# = Speed Code

B: Fab 2 Port Code

W: Die Rev YY: Year

WW: Workweek

1st X: Assembly Code 2nd X: Fab Code

Part Marking

PI49FCT3806

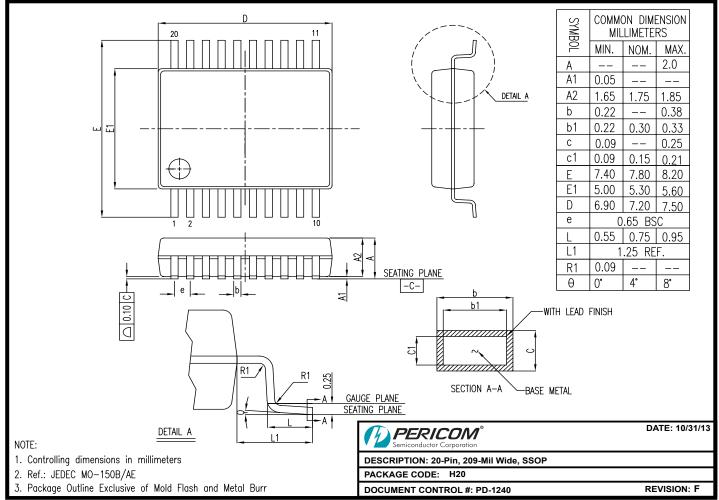
Top mark not available at this time. To obtain advance information regarding the top mark, please contact your local sales representative.

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Packaging Mechanical: 20-SSOP (H20)

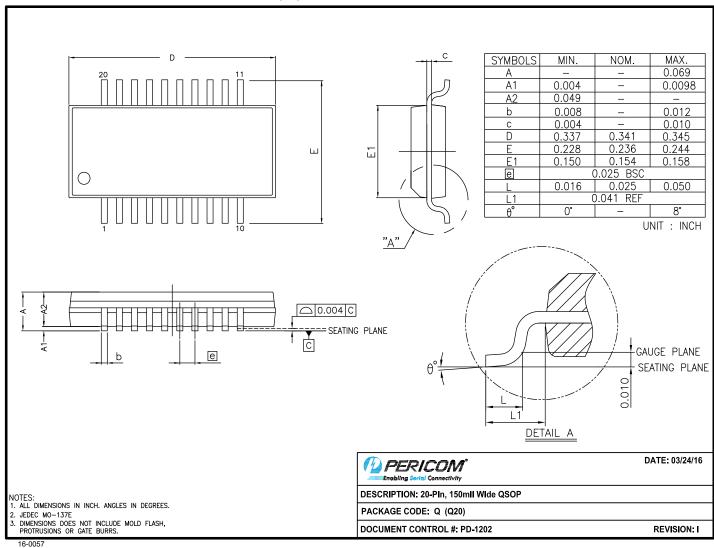


13-0214





Packaging Mechanical: 20-QSOP (Q)



For latest package info.

 $please\ check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/pericom-packaging-packaging-mechanicals-and-thermal-characteristics/pericom-packaging-packaging-mechanicals-and-thermal-characteristics/pericom-packaging-pa$

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PI49FCT3805 Ordering Information

Ordering Code	Package Code	Speed Grade	Package Description
PI49FCT3805BQEX	Q	В	20-pin, 150-mil (QSOP)
PI49FCT3805CHEX	Н	С	20-pin, 209-mil (SSOP)
PI49FCT3805CQEX	Q	С	20-pin, 150-mil (QSOP)
PI49FCT3805QEX	Q	Blank	20-pin, 150-mil (QSOP)

PI49FCT3806 Ordering Information

Ordering Code	Package Code	Speed Grade	Package Description
PI49FCT3806BQEX	Q	В	20-pin, 150-mil (QSOP)

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- $2. \ See \ https://www.diodes.com/quality/lead-free/\ for\ more\ information\ about\ Diodes\ Incorporated's\ definitions\ of\ Halogen-\ and\ Antimony-free,\ "Green"\ and\ Lead-free.$
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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ZL40200LDG1 ZL40205LDG1 9FG1200DF-1LF 9FG1001BGLF PI49FCT20802QE NB7L1008MNG NB7L14MN1G PI49FCT20807QE
PI6C4931502-04LIEX ZL80002QAB1 PI6C4931504-04LIEX PI6C10806BLEX ZL40226LDG1 8T73S208B-01NLGI SY75578LMG
PI49FCT32805QEX PL133-27GC-R CDCV304PWG4 MC10LVEP11DG MC10EP11DTG MC100LVEP11DG MC100E111FNG
MC100EP11DTG NB7L14MMNG NB6L14MMNR2G NB6L611MNG NB7V58MMNHTBG NB3N111KMNR4G ADCLK944BCPZ-R7
ZL40217LDG1 NB7LQ572MNG HMC940LC4BTR 9DB801BGLF ADCLK946BCPZ-REEL7 ADCLK946BCPZ ADCLK905BCPZ-R2
ADCLK905BCPZ-R7 ADCLK907BCPZ-R2 ADCLK907BCPZ-WP ADCLK914BCPZ-R2 ADCLK914BCPZ-R7 ADCLK925BCPZ-R2
ADCLK925BCPZ-R7